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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	F ² MC-16LX
Core Size	16-Bit
Speed	32MHz
Connectivity	CANbus, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	93
Program Memory Size	256KB (256K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90922ncspmc-gs-169e1

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- 16-bit reload timer (4 channels)
16-bit reload timer operation (select toggle output or one-shot output)
Selectable event count function
- Real time watch timer (main clock)
Operates directly from oscillator clock.
Interrupt can be generated by second/minute/hour/date counter overflow.
- PPG timer (6 channels)
Output pins (3 channels), external trigger input pin (1 channel)
Operation clock frequencies : f_{CP} , $f_{CP}/2^2$, $f_{CP}/2^4$, $f_{CP}/2^6$
- Delay interrupt
Generates interrupt for task switching.
Interrupts to CPU can be generated/cleared by software setting.
- External interrupts (8 channels)
8-channel independent operation
Interrupt source setting available : “L” to “H” edge/ “H” to “L” edge/ “L” level/ “H” level.
- 8/10-bit A/D converter (8 channels)
Conversion time : 3 μ s (at $f_{CP} = 32$ MHz)
External trigger activation available (P50/INT0/ADTG)
Internal timer activation available (16-bit reload timer 1)
- UART(LIN/SCI) (4 channels)
Equipped with full duplex double buffer
Clock-asynchronous or clock-synchronous serial transfer is available
- CAN interface (4 channels : CAN0 and CAN2, and CAN1 and CAN3 share transmission and reception pins, and interrupt control registers).
Conforms to CAN specifications version 2.0 Part A and B.
Automatic resend in case of error.
Automatic transfer in response to remote frame.
16 prioritized message buffers for data and ID
Multiple message support
Flexible configuration for receive filter : Full bit compare/full bit mask/two partial bit masks
Supports up to 1 Mbps
CAN wakeup function (RX connected to INT0 internally)
- LCD controller/driver (32 segment x 4 common)
Segment driver and command driver with direct LCD panel (display) drive capability
- Reset on detection of low voltage/program loop
Automatic reset when low voltage is detected
Program looping detection function
- Stepping motor controller (4 channels)
High current output for each channel $\times 4$
Synchronized 8/10-bit PWM for each channel $\times 2$
- Sound generator (2 channels)
8-bit PWM signal mixed with tone frequency from 8-bit reload counter.
PWM frequencies : 125 kHz, 62.5 kHz, 31.2 kHz, 15.6 kHz (at $f_{CP} = 32$ MHz)
Tone frequencies : PWM frequency /2/ , divided by (reload frequency +1)
- Input/output ports
General-purpose input/output port (CMOS output) 93 ports
- Function for port input level selection
Automotive/CMOS-Schmitt
- Flash memory security function
Protects the contents of Flash memory (Flash memory product only)

■ PRODUCT LINEUP

<div>Part number</div> <div>Parameter</div>	MB90 F922NC	MB90 F922NCS	MB90 F923NC	MB90 F923NCS	MB90 F924NC	MB90 F924NCS	MB90 922NCS	MB90 V920-101	MB90 V920-102
Type	Flash memory product						MASK ROM product	Evaluation product	
CPU	F ² MC-16LX CPU								
System clock	PLL clock multiplier circuit (× 1, × 2, × 3, × 4, × 8, 1/2 when PLL stopped) Minimum instruction execution time 31.25 ns (with 4 MHz oscillation clock × 8)								
Sub clock pins (X0A, X1A)	Yes	No	Yes	No	Yes	No	No	No	Yes
ROM	Flash memory 256 Kbytes		Flash memory 384 Kbytes		Flash memory 512 Kbytes		256 K bytes	External	
RAM	10 Kbytes		16 Kbytes		24 Kbytes		10 K bytes	30 Kbytes	
I/O port	91 ports	93 ports	91 ports	93 ports	91 ports	93 ports	93 ports	93 ports	91 ports
LCD controller	32 segment × 4 common								
LIN-UART	UART (LIN/SCI) 4 channels								
CAN interface	4 channels								
16-bit input capture	8 channels								
16-bit reload timer	4 channels								
16-bit free-run timer	1 channel								
Real time watch timer	1 channel								
16-bit PPG timer	6 channels								
External interrupt	8 channels								
8/10-bit A/D converter	8 channels								
Low-voltage/ CPU operating detection reset	Yes						No		
Stepping motor controller	4 channels								
Sound generator	2 channels								
Flash memory security	Yes						—		
Operating voltage	4.0 V to 5.5 V						4.5 V to 5.5 V		
Package	LQFP-120						PGA-299		

- **Notes on operating in PLL clock mode**

On this microcontroller, if in case the crystal oscillator breaks off or an external reference clock input stops while the PLL clock mode is selected, a self-oscillator circuit contained in the PLL may continue its operation at its self-running frequency. However, FUJITSU SEMICONDUCTOR will not guarantee results of operations if such failure occurs.

- **Crystal oscillator circuit**

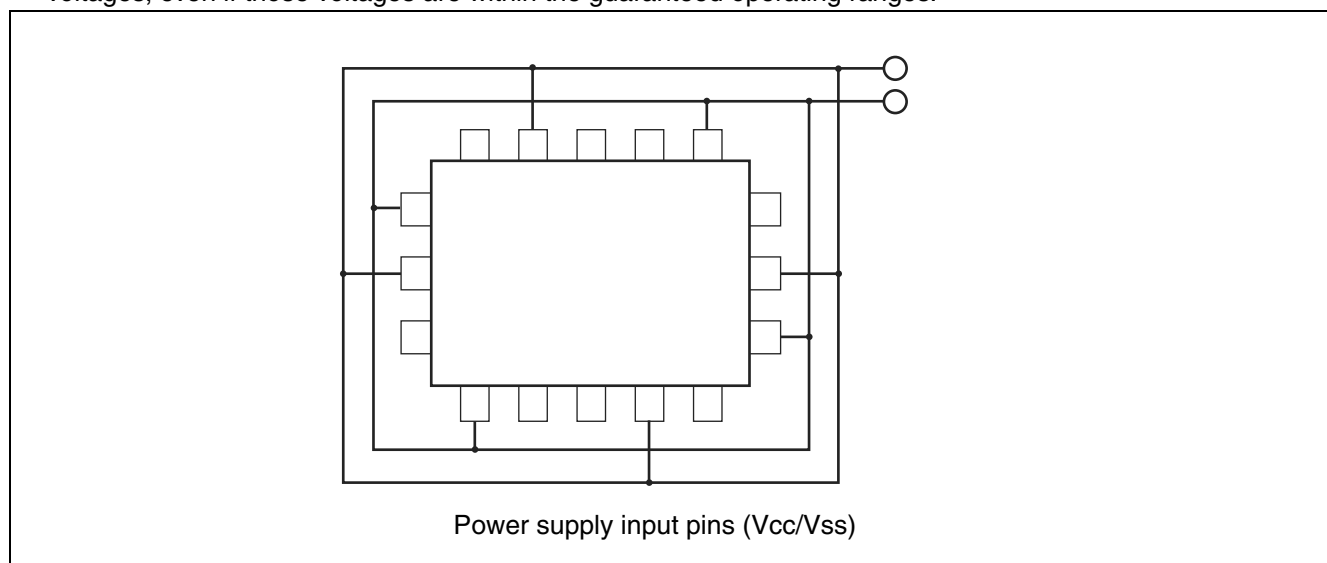
Noise around the X0/X1, or X0A/X1A pins may cause this device to operate abnormally. In the interest of stable operation it is strongly recommended that printed circuit artwork places ground bypass capacitors as close as possible to the X0/X1, X0A/X1A and crystal oscillator (or ceramic oscillator) and that oscillator lines do not cross the lines of other circuits.

Please ask each crystal maker to evaluate the oscillational characteristics of the crystal and this device.

- **Power supply pins**

Devices including multiple VCC or VSS pins are designed such that pins that need to be at the same potential are interconnected internally to prevent malfunctions such as latch-up. To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the VCC and VSS pins to the power supply and ground externally.

Always connect all of the VCC pins to the same potential and all of the VSS pins to ground as shown in the following diagram. The device will not operate correctly if multiple VCC or VSS pins are connected to different voltages, even if those voltages are within the guaranteed operating ranges.



In addition, care must be given to connecting the VCC and VSS pins of this device to the current supply source with as low impedance as possible. It is recommended that a 1.0 μ F bypass capacitor be connected between the VCC and VSS pins as close to the pins as possible.

- **Sequence for connecting the A/D converter power supply and analog inputs**

The A/D converter power supply (AV_{CC} , AV_{RH}) and analog inputs (AN0 to AN7) must be applied after the digital power supply (V_{CC}) is switched on. When turning the power off, the A/D converter power supply and analog inputs must be disconnected before the digital power supply is switched off (V_{CC}). Ensure that AV_{RH} does not exceed AV_{CC} during either power-on or power-off. Even when pins which double as analog input pins are used as input ports, be sure that the input voltage does not exceed AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

■ I/O MAP

Address	Register name	Symbol	Read/write	Resource name	Initial value
000000 _H	Port 0 data register	PDR0	R/W	Port 0	XXXXXXXX _B
000001 _H	Port 1 data register	PDR1	R/W	Port 1	XXXXXXXX _B
000002 _H	Port 2 data register	PDR2	R/W	Port 2	XXXXXXXX _B
000003 _H	Port 3 data register	PDR3	R/W	Port 3	XXXXXXXX _B
000004 _H	Port 4 data register	PDR4	R/W	Port 4	XXXXXXXX _B
000005 _H	Port 5 data register	PDR5	R/W	Port 5	XXXXXXXX _B
000006 _H	Port 6 data register	PDR6	R/W	Port 6	XXXXXXXX _B
000007 _H	Port 7 data register	PDR7	R/W	Port 7	XXXXXXXX _B
000008 _H	Port 8 data register	PDR8	R/W	Port 8	XXXXXXXX _B
000009 _H	Port 9 data register	PDR9	R/W	Port 9	XXXXXXXX _B
00000A _H , 00000B _H	(Disabled)				
00000C _H	Port C data register	PDRC	R/W	Port C	XXXXXXXX _B
00000D _H	Port D data register	PDRD	R/W	Port D	XXXXXXXX _B
00000E _H	Port E data register	PDRE	R/W	Port E	XXXXXXXX _B
00000F _H	(Disabled)				
000010 _H	Port 0 direction register	DDR0	R/W	Port 0	00000000 _B
000011 _H	Port 1 direction register	DDR1	R/W	Port 1	XX000000 _B
000012 _H	Port 2 direction register	DDR2	R/W	Port 2	000000XX _B
000013 _H	Port 3 direction register	DDR3	R/W	Port 3	00000000 _B
000014 _H	Port 4 direction register	DDR4	R/W	Port 4	00000000 _B
000015 _H	Port 5 direction register	DDR5	R/W	Port 5	00000000 _B
000016 _H	Port 6 direction register	DDR6	R/W	Port 6	00000000 _B
000017 _H	Port 7 direction register	DDR7	R/W	Port 7	00000000 _B
000018 _H	Port 8 direction register	DDR8	R/W	Port 8	00000000 _B
000019 _H	Port 9 direction register	DDR9	R/W	Port 9	X0000000 _B
00001A _H	Analog input enable	ADER6	R/W	Port 6, A/D	11111111 _B
00001B _H	(Disabled)				
00001C _H	Port C direction register	DDRC	R/W	Port C	00000000 _B
00001D _H	Port D direction register	DDRD	R/W	Port D	X0000000 _B
00001E _H	Port E direction register	DDRE	R/W	Port E	XXXXX000 _B
00001F _H	(Disabled)				
000020 _H	Lower A/D control status register	ADCS0	R/W	A/D converter	000XXXX0 _B
000021 _H	Higher A/D control status register	ADCS1	R/W		0000000X _B
000022 _H	Lower A/D control status register	ADCR0	R		00000000 _B
000023 _H	Higher A/D data register	ADCR1	R		XXXXXX00 _B

(Continued)

MB90920 Series

Address	Register name	Symbol	Read/write	Resource name	Initial value
000024 _H	Compare clear register	CPCLR	R/W	16-bit free-run timer	XXXXXXXX _B
000025 _H			R/W		XXXXXXXX _B
000026 _H	Timer data register	TCDT	R/W		00000000 _B
000027 _H			R/W		00000000 _B
000028 _H	Lower timer control status register	TCCSL	R/W		00000000 _B
000029 _H	Higher timer control status register	TCCSH	R/W		01-00000 _B
00002A _H	Lower PPG0 control status register	PCNTL0	R/W	16-bit PPG0	00000000 _B
00002B _H	Higher PPG0 control status register	PCNTH0	R/W		00000001 _B
00002C _H	Lower PPG1 control status register	PCNTL1	R/W	16-bit PPG1	00000000 _B
00002D _H	Higher PPG1 control status register	PCNTH1	R/W		00000001 _B
00002E _H	Lower PPG2 control status register	PCNTL2	R/W	16-bit PPG2	00000000 _B
00002F _H	Higher PPG2 control status register	PCNTH2	R/W		00000001 _B
000030 _H	External interrupt enable	ENIR	R/W	External interrupt	00000000 _B
000031 _H	External interrupt request	EIRR	R/W		00000000 _B
000032 _H	Lower external interrupt level	ELVRL	R/W		00000000 _B
000033 _H	Higher external interrupt level	ELVRH	R/W		00000000 _B
000034 _H	Serial mode register 0	SMR0	R/W, W	UART (LIN/SCI) 0	00000000 _B
000035 _H	Serial control register 0	SCR0	R/W, W		00000000 _B
000036 _H	Reception/transmission data register 1	RDR0/ TDR0	R/W		00000000 _B
000037 _H	Serial status register 0	SSR0	R/W, R		00001000 _B
000038 _H	Extended communication control register 0	ECCR0	R/W, R		000000XX _B
000039 _H	Extended status control register 0	ESCR0	R/W		00000100 _B
00003A _H	Baud rate generator register 00	BGR00	R/W		00000000 _B
00003B _H	Baud rate generator register 01	BGR01	R/W, R		00000000 _B
00003C _H to 00003F _H	(Disabled)				
000040 _H to 00004F _H	Area reserved for CAN Controller 0. Refer to “■ CAN CONTROLLERS”				
000050 _H	Lower timer control status register 0	TMCSR0L	R/W	16-bit reload timer 0	00000000 _B
000051 _H	Higher timer control status register 0	TMCSR0H	R/W		XXX10000 _B
000052 _H	Timer register 0/reload register 0	TMR0/ TMRLR0	R/W		XXXXXXXX _B
000053 _H					XXXXXXXX _B

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
000054 _H	Lower timer control status register 1	TMCSR1L	R/W	16-bit reload timer 1	00000000 _B
000055 _H	Higher timer control status register 1	TMCSR1H	R/W		XXX10000 _B
000056 _H	Timer register 1/reload register 1	TMR1/ TMRLR1	R/W		XXXXXXXX _B
000057 _H					XXXXXXXX _B
000058 _H	LCD output control register 1	LOCR1	R/W	LCDC	11111111 _B
000059 _H	LCD output control register 2	LOCR2	R/W		00000000 _B
00005A _H	Lower sound control register 0	SGCRL0	R/W	Sound generator 0	00000000 _B
00005B _H	Higher sound control register 0	SGCRH0	R/W		0XXXX100 _B
00005C _H	Frequency data register 0	SGFR0	R/W		XXXXXXXX _B
00005D _H	Amplitude data register 0	SGAR0	R/W		00000000 _B
00005E _H	Decrement grade register 0	SGDR0	R/W		XXXXXXXX _B
00005F _H	Tone count register 0	SGTR0	R/W		XXXXXXXX _B
000060 _H	Input capture register 0	IPCP0	R	Input capture 0/1	XXXXXXXX _B
000061 _H					XXXXXXXX _B
000062 _H	Input capture register 1	IPCP1	R		XXXXXXXX _B
000063 _H					XXXXXXXX _B
000064 _H	Input capture register 2	IPCP2	R	Input capture 2/3	XXXXXXXX _B
000065 _H					XXXXXXXX _B
000066 _H	Input capture register 3	IPCP3	R		XXXXXXXX _B
000067 _H					XXXXXXXX _B
000068 _H	Input capture control status 0/1	ICS01	R/W	Input capture 0/1	00000000 _B
000069 _H	Input capture edge register 0/1	ICE01	R/W		XXX0X0XX _B
00006A _H	Input capture control status 2/3	ICS23	R/W	Input capture 2/3	00000000 _B
00006B _H	Input capture edge register 2/3	ICE23	R/W		XXXXXXXX _B
00006C _H	Lower LCD control register	LCRL	R/W	LCD controller/ driver	00010000 _B
00006D _H	Higher LCD control register	LCRH	R/W		00000000 _B
00006E _H	Low voltage/CPU operation detection reset control register	LVRC	R/W	Low voltage/CPU operation detection reset	00111000 _B
00006F _H	ROM mirror	ROMM	W	ROM mirror	XXXXXXXX1 _B
000070 _H to 00007F _H	Area reserved for CAN Controller 1. Refer to “■ CAN CONTROLLERS”				
000080 _H	PWM control register 0	PWC0	R/W	Stepping motor controller 0	000000X0 _B
000081 _H	(Disabled)				
000082 _H	PWM control register 1	PWC1	R/W	Stepping motor controller 1	000000X0 _B

(Continued)

Address	Register name	Symbol	Read/write	Resource name	Initial value
0000B0 _H	Interrupt control register 00	ICR00	R/W	Interrupt controller	00000111 _B
0000B1 _H	Interrupt control register 01	ICR01	R/W		00000111 _B
0000B2 _H	Interrupt control register 02	ICR02	R/W		00000111 _B
0000B3 _H	Interrupt control register 03	ICR03	R/W		00000111 _B
0000B4 _H	Interrupt control register 04	ICR04	R/W		00000111 _B
0000B5 _H	Interrupt control register 05	ICR05	R/W		00000111 _B
0000B6 _H	Interrupt control register 06	ICR06	R/W		00000111 _B
0000B7 _H	Interrupt control register 07	ICR07	R/W		00000111 _B
0000B8 _H	Interrupt control register 08	ICR08	R/W		00000111 _B
0000B9 _H	Interrupt control register 09	ICR09	R/W		00000111 _B
0000BA _H	Interrupt control register 10	ICR10	R/W		00000111 _B
0000BB _H	Interrupt control register 11	ICR11	R/W		00000111 _B
0000BC _H	Interrupt control register 12	ICR12	R/W		00000111 _B
0000BD _H	Interrupt control register 13	ICR13	R/W		00000111 _B
0000BE _H	Interrupt control register 14	ICR14	R/W		00000111 _B
0000BF _H	Interrupt control register 15	ICR15	R/W		00000111 _B
0000C0 _H to 0000C3 _H	(Disabled)				
0000C4 _H	Serial mode register 1	SMR1	R/W, W	UART (LIN/SCI) 1	00000000 _B
0000C5 _H	Serial control register 1	SCR1	R/W, W		00000000 _B
0000C6 _H	Reception/transmission data register 1	RDR1/ TDR1	R/W		00000000 _B
0000C7 _H	Serial status register 1	SSR1	R/W, R		00001000 _B
0000C8 _H	Extended communication control register 1	ECCR1	R/W, R		000000XX _B
0000C9 _H	Extended status control register 1	ESCR1	R/W		00000100 _B
0000CA _H	Baud rate generator register 10	BGR10	R/W		00000000 _B
0000CB _H	Baud rate generator register 11	BGR11	R/W, R		00000000 _B
0000CC _H	Lower watch timer control register	WTCRL	R/W	Real-time watch timer	000XXXX0 _B
0000CD _H	Middle watch timer control register	WTCRM	R/W		00000000 _B
0000CE _H	Higher watch timer control register	WTCRH	R/W		XXXXXX00 _B
0000CF _H	Sub clock control register	PSCCR	W	Sub clock	XXXX0000 _B
0000D0 _H	Input capture control status 4/5	ICS45	R/W	Input capture 4/5	00000000 _B
0000D1 _H	Input capture edge register 4/5	ICE45	R/W, R		XXXXXXXX _B
0000D2 _H	Input capture control status 6/7	ICS67	R/W	Input capture 6/7	00000000 _B
0000D3 _H	Input capture edge register 6/7	ICE67	R/W, R		XXX0X0XX _B

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MB90920 Series

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Address	Register name	Symbol	Read/write	Resource name	Initial value
003998 _H	PWM1 compare register 3	PWC13	R/W	Stepping motor controller 3	XXXXXXXX _B
003999 _H					XXXXXXXX _B
00399A _H	PWM2 compare register 3	PWC23	R/W		XXXXXXXX _B
00399B _H					XXXXXXXX _B
00399C _H	PWM1 select register 3	PWS13	R/W		00000000 _B
00399D _H	PWM2 select register 3	PWS23	R/W		X0000000 _B
00399E _H to 0039A5 _H	(Disabled)				
0039A6 _H	Flash write control register 0	FWR0	R/W	Flash I/F	00000000 _B
0039A7 _H	Flash write control register 1	FWR1			00000000 _B
0039A8 _H to 0039BF _H	(Disabled)				
0039C0 _H to 0039DF _H	Area reserved for CAN Controller 2. Refer to “■ CAN CONTROLLERS”				
0039E0 _H to 0039FF _H	Area reserved for CAN Controller 3. Refer to “■ CAN CONTROLLERS”				
003A00 _H to 003AFF _H	Area reserved for CAN Controller 0. Refer to “■ CAN CONTROLLERS”				
003B00 _H to 003BFF _H	Area reserved for CAN Controller 1. Refer to “■ CAN CONTROLLERS”				
003C00 _H to 003CFF _H	Area reserved for CAN Controller 0. Refer to “■ CAN CONTROLLERS”				
003D00 _H to 003DFF _H	Area reserved for CAN Controller 1. Refer to “■ CAN CONTROLLERS”				
003E00 _H to 003EFF _H	Area reserved for CAN Controller 2. Refer to “■ CAN CONTROLLERS”				
003F00 _H to 003FFF _H	Area reserved for CAN Controller 3. Refer to “■ CAN CONTROLLERS”				

■ INTERRUPT SOURCES, INTERRUPT VECTORS, AND INTERRUPT CONTROL REGISTERS

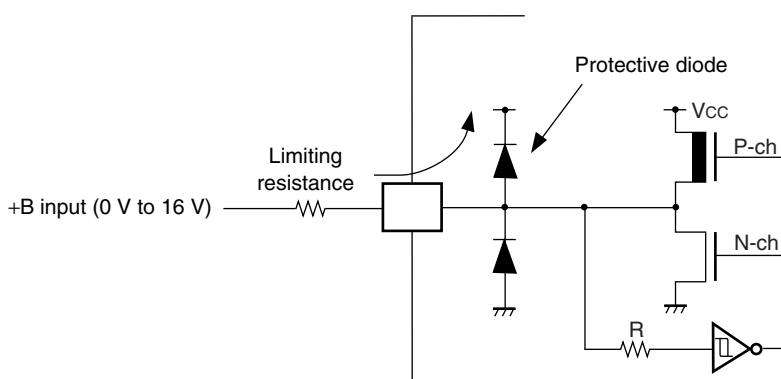
Interrupt source	EI ² OS corresponding	Interrupt vector			Interrupt control register		Priority *2
		Number		Address	ICR	Address	
Reset	×	#08	08 _H	FFFFDC _H	—	—	<div>High</div> <div>↑</div> <div>↓</div> <div>Low</div>
INT9 instruction	×	#09	09 _H	FFFFD8 _H	—	—	
Exception processing	×	#10	0A _H	FFFFD4 _H	—	—	
CAN0 received/CAN2 received	×	#11	0B _H	FFFFD0 _H	ICR00	0000B0 _H *1	
CAN0 transmitted/node status/ CAN2 transmitted/node status	×	#12	0C _H	FFFFCC _H			
CAN1 received/CAN3 received	×	#13	0D _H	FFFFC8 _H	ICR01	0000B1 _H *1	
CAN1 transmitted/node status/ CAN3 transmitted/node status/SIO	×	#14	0E _H	FFFFC4 _H			
Input capture 0	△	#15	0F _H	FFFFC0 _H	ICR02	0000B2 _H *1	
DTP/ external interrupt - ch.0/ch.1 detected	△	#16	10 _H	FFFFBC _H			
Reload timer 0	△	#17	11 _H	FFFFB8 _H	ICR03	0000B3 _H *1	
Reload timer 2	△	#18	12 _H	FFFFB4 _H			
Input capture 1	△	#19	13 _H	FFFFB0 _H	ICR04	0000B4 _H *1	
DTP/ external interrupt - ch.2/ch.3 detected	△	#20	14 _H	FFFFAC _H			
Input capture 2	△	#21	15 _H	FFFFA8 _H	ICR05	0000B5 _H *1	
Reload timer 3	△	#22	16 _H	FFFFA4 _H			
Input capture 3/4/5/6/7	△	#23	17 _H	FFFFA0 _H	ICR06	0000B6 _H *1	
DTP/ external interrupt - ch.4/ ch.5 detected UART3 RX	△	#24	18 _H	FFFF9C _H			
PPG timer 0	△	#25	19 _H	FFFF98 _H	ICR07	0000B7 _H *1	
DTP/ external interrupt - ch.6/ ch.7 detected UART3 TX	△	#26	1A _H	FFFF94 _H			
PPG timer 1	△	#27	1B _H	FFFF90 _H	ICR08	0000B8 _H *1	
Reload timer 1	△	#28	1C _H	FFFF8C _H			
PPG timer 2/3/4/5	○	#29	1D _H	FFFF88 _H	ICR09	0000B9 _H *1	
Real time watch timer watch timer (sub clock)	×	#30	1E _H	FFFF84 _H			
Free-run timer overflow/clear	×	#31	1F _H	FFFF80 _H	ICR10	0000BA _H *1	
A/D converter conversion complete	○	#32	20 _H	FFFF7C _H			
Sound generator 0/1	×	#33	21 _H	FFFF78 _H	ICR11	0000BB _H *1	
Time-base timer	×	#34	22 _H	FFFF74 _H			
UART2 RX	○	#35	23 _H	FFFF70 _H	ICR12	0000BC _H *1	
UART2 TX	△	#36	24 _H	FFFF6C _H			

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- *5 : Average output current is defined as the average value of the current flowing through any one of the corresponding pins within a period of 100 ms. The “average value” can be calculated by multiplying the “operating current” by the “operating factor”.
- *6 : Average total output current is defined as the average value of the current flowing through all of the corresponding pins within a period of 100 ms. The “average value” can be calculated by multiplying the “operating current” by the “operating factor”.
- *7 :
 - Applicable to pins: P10 to P15, P50 to P57, P60 to P67, P70 to P77, P80 to P87, PC0 to PC7, PD0 to PD6, PE0 to PE2
 - Use within recommended operating conditions.
 - Use at DC voltage (current) .
 - The +B signal should always be applied with a limiting resistance placed between the +B signal and the microcontroller.
 - The value of the limiting resistance should be set so that when the +B signal is applied, the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
 - Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
 - Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V) , the microcontroller may partially malfunction on power supplied through the +B signal pin.
 - Note that if the +B input is applied during power-on, the power supply voltage may reach a level such that the power-on reset does not function due to the power supplied from the +B signal.
 - Care must be taken not to leave +B input pins open.
 - Note that analog system input/output pins (LCD drive pins, comparator input pins, etc.) cannot accept +B signal inputs.
 - Sample recommended circuit :

- Input/output equivalent circuit



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

MB90920 Series

($V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = DV_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+105 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Input leakage current	I_{IL}	All input pins	$V_{CC} = DV_{CC} = AV_{CC} = 5.5 \text{ V}$, $V_{SS} < V_I < V_{CC}$	—	—	10	μA	
Input capacitance 1	C_{IN1}	All pins except V_{CC} , V_{SS} , DV_{CC} , DV_{SS} , AV_{CC} , AV_{SS} , C, P70 to P77, P80 to P87	—	—	—	15	pF	
Input capacitance 2	C_{IN2}	P70 to P77, P80 to P87	—	—	—	45	pF	
Pull-up resistance	R_{UP}	\overline{RST}	—	25	50	100	k Ω	
Pull-down resistance	R_{DOWN}	MD2	—	—	—	100	k Ω	Excluding Flash memory product
General-purpose output “H” voltage	V_{OH1}	All pins except P70 to P77, P80 to P87	$V_{CC} = 4.5 \text{ V}$, $I_{OH} = -4.0 \text{ mA}$	$V_{CC} - 0.5$	—	—	V	
Stepping motor output “H” voltage	V_{OH2}	P70 to P77, P80 to P87	$V_{CC} = 4.5 \text{ V}$, $I_{OH} = -30.0 \text{ mA}$	$V_{CC} - 0.5$	—	—	V	
General-purpose output “L” voltage	V_{OL1}	All pins except P70 to P77, P80 to P87	$V_{CC} = 4.5 \text{ V}$, $I_{OL} = 4.0 \text{ mA}$	—	—	0.4	V	
Stepping motor output “L” voltage	V_{OL2}	P70 to P77, P80 to P87	$V_{CC} = 4.5 \text{ V}$, $I_{OL} = 30.0 \text{ mA}$	—	—	0.55	V	
Stepping motor output phase variation “H”	ΔV_{OH}	PWM1Pn, PWM1Mn, PWM2Pn, PWM2Mn, n = 0 to 3	$V_{CC} = 4.5 \text{ V}$, $I_{OH} = -30.0 \text{ mA}$, maximum deviation V_{OH2}	—	—	90	mV	
Stepping motor output phase variation “L”	ΔV_{OL}	PWM1Pn, PWM1Mn, PWM2Pn, PWM2Mn, n = 0 to 3	$V_{CC} = 4.5 \text{ V}$, $I_{OL} = 30.0 \text{ mA}$, maximum deviation V_{OH2}	—	—	90	mV	
LCD internal divider resistance	R_{LCD}	Between V0 and V1, Between V1 and V2, Between V2 and V3	—	50	100	200	k Ω	Evaluation product
				8.75	12.5	17.0	k Ω	Flash memory product

(Continued)

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(Continued)

($V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = DV_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+105 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
LCDC leakage current	I_{LCDC}	V0 to V3, COMm (m = 0 to 3) , SEGn, (n = 00 to 31)	—	—	—	5.0	μA	
LCD output impedance	R_{vcom}	COMn (n = 0 to 3)	—	—	—	4.5	$\text{k}\Omega$	
	R_{vseg}	SEGn (n = 00 to 31)	—	—	—	17	$\text{k}\Omega$	

* : Power supply current values assume an external clock supplied to the X1 pin and X1A pin. Users must be aware that power supply current levels differ depending on whether an external clock or oscillator is used.

4. AC Characteristics

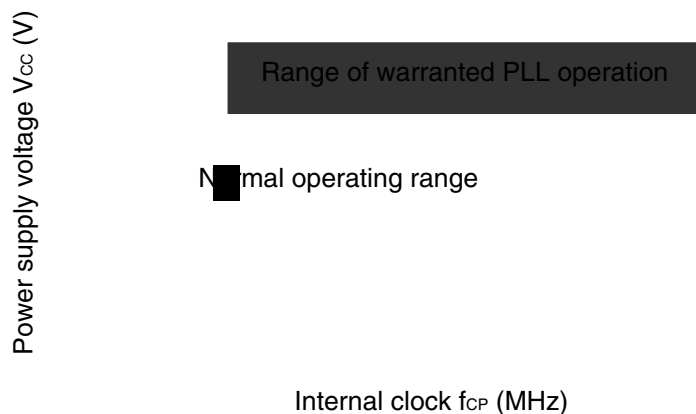
(1) Clock timing

($V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = DV_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^\circ\text{C}$ to $+105 \text{ }^\circ\text{C}$)

Parameter	Symbol	Pin name	Condi- tions	Value			Unit	Remarks
				Min	Typ	Max		
Clock frequency	F _C	X0, X1	—	3	—	16	MHz	1/2 (PLL stopped) When using the oscillator circuit
				3	—	32	MHz	1/2 (PLL stopped) When using an external clock
				4	—	32	MHz	PLL multiplied by 1
				3	—	16	MHz	PLL multiplied by 2
				3	—	10.7	MHz	PLL multiplied by 3
				3	—	8	MHz	PLL multiplied by 4
				3	—	5.33	MHz	PLL multiplied by 6
				3	—	4	MHz	PLL multiplied by 8
	F _{LC}	X0A, X1A		—	32.768	—	kHz	
Clock cycle time	t _{CYL}	X0, X1		62.5	—	333	ns	When using an oscillator
				31.25	—	333	ns	External clock input
	t _{LCYL}	X0A, X1A		—	30.5	—	μs	
Input clock pulse width	P _{WH} , P _{WL}	X0		5	—	—	ns	Use duty ratio of 50% ± 3% as a guideline
	P _{WLH} , P _{WLL}	X0A		—	15.2	—	μs	
Input clock rise and fall time	t _{cr} , t _{cf}	X0		—	—	5	ns	When using an external clock signal
Internal operating clock frequency	F _{CP}	—		1.5	—	32	MHz	Using main clock (PLL clock)
	F _{LCP}	—		—	8.192	—	kHz	Using sub clock
Internal operating clock cycle time	t _{CP}	—		31.25	—	666	ns	Using main clock (PLL clock)
	t _{LCP}	—		—	122.1	—	μs	Using sub clock

• Guaranteed PLL Operation Range

Internal operating clock frequency vs. Power supply voltage



- Notes :
- For PLL 1 × only, use with $f_{CP} = 4$ MHz or greater.
 - Refer to “5. A/D Converter (1) Electrical Characteristics” for details on the A/D converter operating frequency.

(Continued)

(2) Reset input

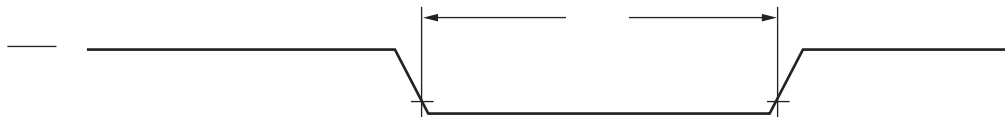
($V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+105 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	\overline{RST}	500	—	ns	During normal operation
			Oscillator oscillation time* + $16 t_{CP}$	—	ms	In stop mode, sub clock mode, sub sleep mode, and watch mode
			100	—	μs	In time-base timer mode

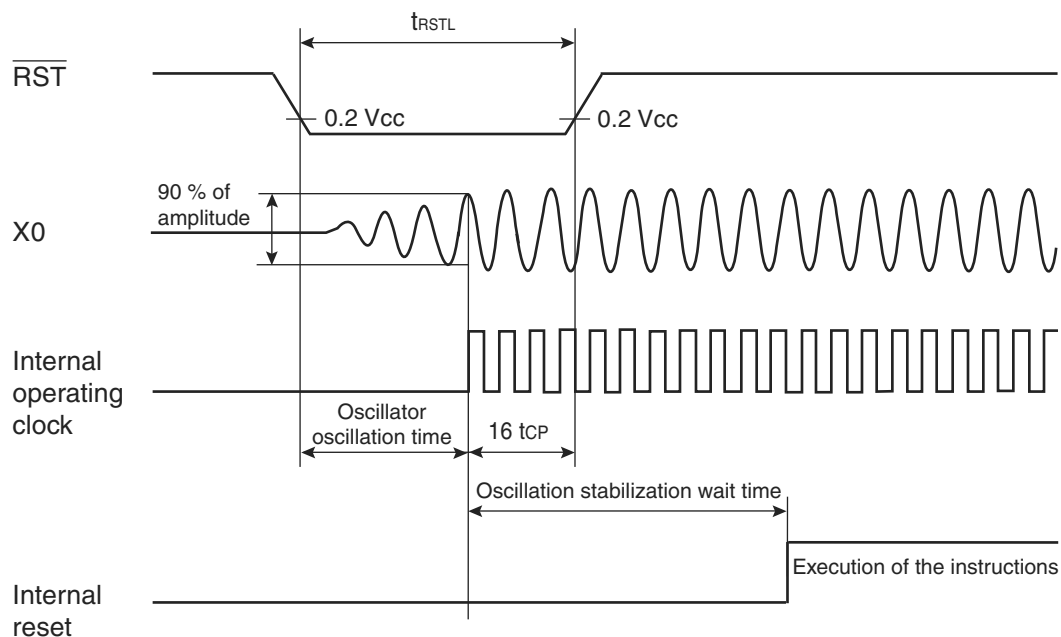
*: The oscillation time of the oscillator is the time taken to reach 90% of the amplitude. The oscillation time of a crystal oscillator is between several ms and tens of ms. The oscillation time of a ceramic oscillator is between hundreds of μs and several ms. The oscillation time of an external clock is 0 ms.

Note : t_{CP} is the internal operating clock cycle time. (Unit : ns)

- During normal operation



- In stop mode, sub clock mode, sub sleep mode, watch mode, and power-on



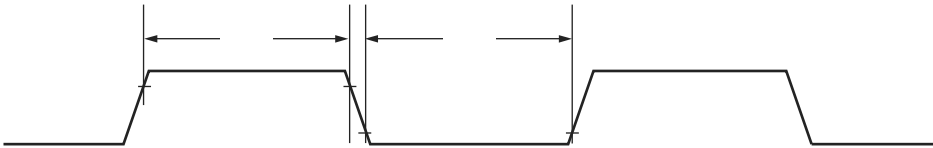
(5) Timer input timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = -40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Input pulse width	t _{TIWH} t _{TIWL}	TIN0, TIN1, IN0 to IN3	—	4 t _{CP}	—	ns

Note : t_{CP} is the internal operating clock cycle time. Refer to “ (1) Clock timing”.

- Timer input timing



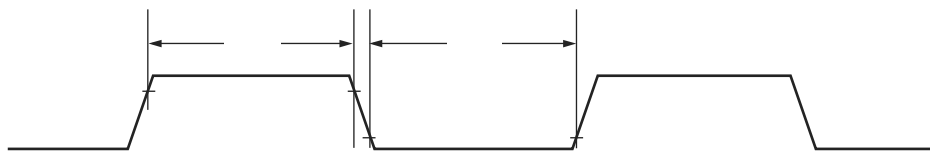
(6) Trigger input timing

($V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH} , t_{TRGL}	INT0 to INT7	—	200	—	ns	During normal operation
		ADTG	—	$t_{CP} + 200$	—	ns	

Note : t_{CP} is the internal operating clock cycle time. Refer to “(1) Clock timing”.

- Trigger input timing



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5. A/D Converter

(1) Electrical Characteristics

($V_{CC} = AV_{CC} = AVRH = 4.0\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Total error	—	—	− 3.0	—	+ 3.0	LSB	
Non-linear error	—	—	− 2.5	—	+ 2.5	LSB	
Differential linear error	—	—	− 1.9	—	+ 1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	$AV_{SS} - 1.5\text{ LSB}$	$AV_{SS} + 0.5\text{ LSB}$	$AV_{SS} + 2.5\text{ LSB}$	V	1 LSB = ($AVRH - AV_{SS}$) / 1024
Full scale transition voltage	V_{FST}	AN0 to AN7	$AVRH - 3.5\text{ LSB}$	$AVRH - 1.5\text{ LSB}$	$AVRH + 0.5\text{ LSB}$	V	
Sampling time	t_{SMP}	—	0.4	—	16500	μs	4.5 V \leq $AV_{CC} \leq$ 5.5 V
			1.0				4.0 V \leq $AV_{CC} \leq$ 4.5 V
Compare time	t_{CMP}	—	0.66	—	—	μs	4.5 V \leq $AV_{CC} \leq$ 5.5 V
			2.2				4.0 V \leq $AV_{CC} \leq$ 4.5 V
A/D conversion time	t_{CNV}	—	1.44	—	—	μs	*1
Analog port input current	I_{AIN}	AN0 to AN7	− 0.3	—	+ 10	μA	
Analog input voltage	V_{AIN}	AN0 to AN7	0	—	$AVRH$	V	
Reference voltage	$AV+$	$AVRH$	$AV_{SS} + 2.7$	—	AV_{CC}	V	
Power supply current	I_A	AV_{CC}	—	2.3	6.0	mA	
	I_{AH}		—	—	5	μA	*2
Reference voltage supply current	I_R	$AVRH$	—	520	900	μA	$V_{AVRH} = 5.0\text{ V}$
	I_{RH}		—	—	5	μA	*2
Inter-channel variation	—	AN0 to AN7	—	—	4	LSB	

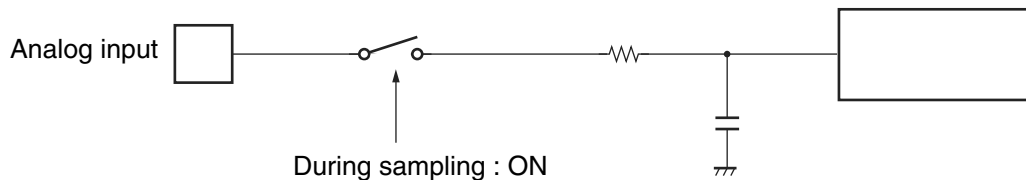
*1 : The time per channel (4.5 V \leq $AV_{CC} \leq$ 5.5 V, and internal operating frequency = 32 MHz) .

*2 : Defined as supply current (when $V_{CC} = AV_{CC} = AVRH = 5.0\text{ V}$) with A/D converter not operating, and CPU in stop mode.

• Notes on the external impedance and sampling time of analog inputs

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. If the sampling time is still not sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• Analog input equivalent circuit



MB90F922NC/F922NCS/ F923NC/F923NCS/F924NC/F924NCS
MB90922NCS

	R	C
$4.5\text{ V} \leq \text{AVcc} \leq 5.5\text{ V}$	2.6 k Ω (Max)	8.5 pF (Max)
$4.0\text{ V} \leq \text{AVcc} \leq 4.5\text{ V}$	12.1 k Ω (Max)	8.5 pF (Max)

MB90V920-101/102

$4.5\text{ V} \leq \text{AVcc} \leq 5.5\text{ V}$	2.0 k Ω (Max)	14.4 pF (Max)
$4.0\text{ V} \leq \text{AVcc} \leq 4.5\text{ V}$	8.2 k Ω (Max)	14.4 pF (Max)

Note : The values are reference values.

MB90920 Series

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